### Product / Package Information

**Package**
- LFCSP - Punched

**Body Size (mm)**
- 12 X 12 X 0.85 (7.4 EP)

**Lead Count**
- 88

**Terminal Finish**
- 100 Sn

**MS Number**
- MS010673B

### Environmental Information

- **RoHS Compliant**: Yes
- **High Temperature Compliant**: Yes
- **Halogen Free Compliant**: Yes
- **REACH SVHC Compliant**: Yes

### Materials Declaration

#### Molding Compound

<table>
<thead>
<tr>
<th>Description</th>
<th>Substance</th>
<th>CAS#</th>
<th>Weight (g)</th>
<th>Homogeneous Material Level</th>
<th>Component Level</th>
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<td>Other inorganic materials</td>
<td>Silica</td>
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<td>Thermostats</td>
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#### Leadframe

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<tr>
<th>Description</th>
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<th>Homogeneous Material Level</th>
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<tr>
<td>Copper &amp; its alloys</td>
<td>Copper</td>
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#### External Leadframe Plating

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#### Chip

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#### Die Attach

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**Package Totals**

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Note: The information provided in this declaration are true to the best of ADI’s knowledge. ADI derived most of the information listed in this declaration from documents provided by third parties, and assumes no liability to any inaccuracy of such information.